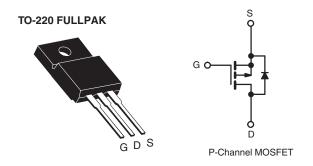


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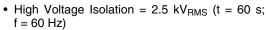
## **Power MOSFET**

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	- 200		
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = - 10 V	1.5	
Q <sub>g</sub> (Max.) (nC)	15		
Q <sub>gs</sub> (nC)	3.2		
Q <sub>gd</sub> (nC)	8.4		
Configuration	Single		



### **FEATURES**

· Isolated Package





- Sink to Lead Creepage Dist. = 4.8 mm
- P-Channel
- Dynamic dV/dt
- · Low Thermal Resistance
- · Lead (Pb)-free Available

### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION				
Package	TO-220 FULLPAK			
Lead (Pb)-free	IRFI9620GPbF			
	SiHFl9620G-E3			
SnPb	IRFI9620G			
SIIFD	SiHFl9620G			

ABSOLUTE MAXIMUM RATINGS T	<sub>C</sub> = 25 °C, u	nless otherw	ise noted		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	- 200	V
Gate-Source Voltage			$V_{GS}$	± 20	v
Continuous Drain Current	V -1 40 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$	I <sub>D</sub>	- 3.0	
	VGS at - 10 V	T <sub>C</sub> = 100 °C		- 1.9	Α
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 12	
Linear Derating Factor				0.24	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	80	mJ
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	- 3.0	Α
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	3.0	mJ
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		$P_{D}$	30	W
Peak Diode Recovery dV/dtc			dV/dt	- 5.0	V/ns
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s			300 <sup>d</sup>	7
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in
				1.1	N · m

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 13 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AS}$  = 3.0 A (see fig. 12). c.  $I_{SD}$  ≤ 3.9 A,  $I_{CS}$  = 3.9 A,  $I_{CS}$  = 3.0 A (see fig. 12).

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFI9620G, SiHFI9620G

# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	4.1	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	- 200	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	-	- 0.22	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- 2.0	-	- 4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V			± 100	nA
Zava Cata Valtana Daria Carrent		V <sub>DS</sub> =	V <sub>DS</sub> = - 200 V, V <sub>GS</sub> = 0 V		-	- 100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 160	V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	- 500	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 1.8 A <sup>b</sup>	-	-	1.5	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	- 50 V, I <sub>D</sub> = - 1.8 A <sup>b</sup>	1.3	-	-	S
Dynamic							•
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	340	-	pF
Output Capacitance	C <sub>oss</sub>		$V_{DS} = -15 V$ ,		110	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	33	-	
Drain to Sink Capacitance	С		f = 1 MHz	-	12	-	
Total Gate Charge	Qg		I <sub>D</sub> = - 2.1 A, V <sub>DS</sub> = - 160 V, see fig. 6 and 13 <sup>b</sup>	-	-	15	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V		-	-	3.2	
Gate-Drain Charge	Q <sub>gd</sub>	1	See fig. 6 and 16	-	-	8.4	
Turn-On Delay Time	t <sub>d(on)</sub>			-	8.8	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 100 V, $I_{D}$ = - 3.9 A, $R_{G}$ = 18 $\Omega$ , $R_{D}$ = 24 $\Omega$ , see fig. 10 <sup>b</sup>		-	27	-	- ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	7.3	-	
Fall Time	t <sub>f</sub>	7			19	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						,
Continuous Source-Drain Diode Current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	- 3.0	- A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		i	-	- 12	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = -3.0  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$		-	-	- 6.3	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$-$ T <sub>J</sub> = 25 °C, I <sub>F</sub> = - 3.9 A, dI/dt = 100 A/ $\mu$ s <sup>b</sup>		-	150	300	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.97	2.0	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				_D)	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

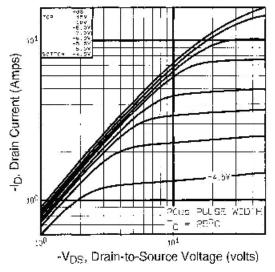


Fig. 1 - Typical Output Characteristics,  $T_C$  = 25 °C

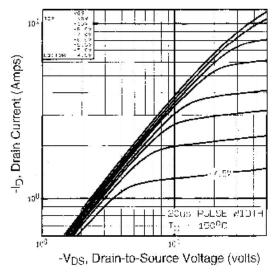


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

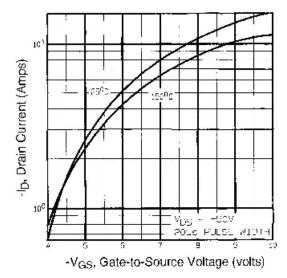


Fig. 3 - Typical Transfer Characteristics

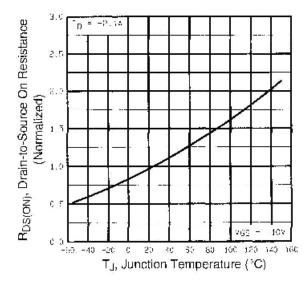


Fig. 4 - Normalized On-Resistance vs. Temperature

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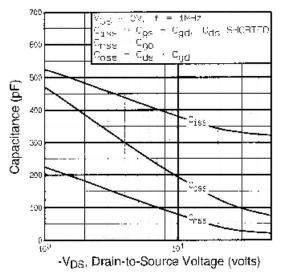


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

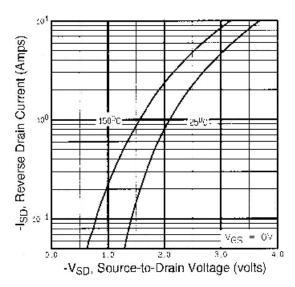


Fig. 7 - Typical Source-Drain Diode Forward Voltage

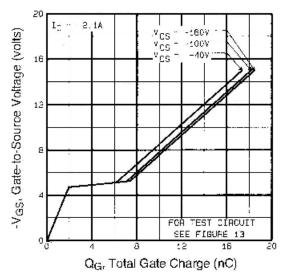


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

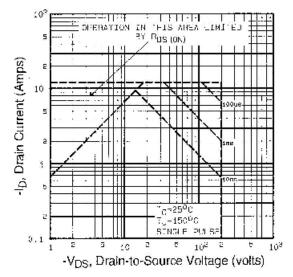
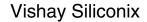


Fig. 8 - Maximum Safe Operating Area





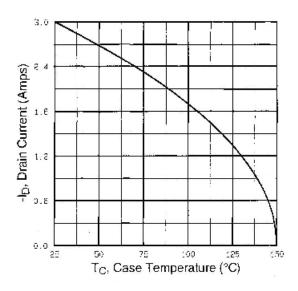


Fig. 9 - Maximum Drain Current vs. Case Temperature

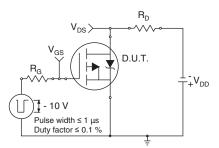


Fig. 10a - Switching Time Test Circuit

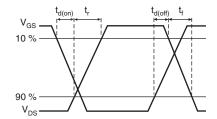


Fig. 10b - Switching Time Waveforms

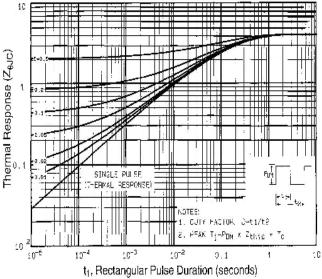


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

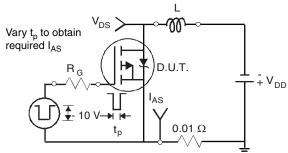


Fig. 12a - Unclamped Inductive Test Circuit

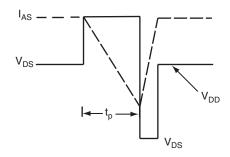


Fig. 12b - Unclamped Inductive Waveforms

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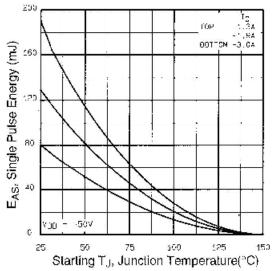


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

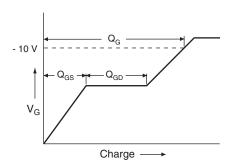


Fig. 13a - Basic Gate Charge Waveform

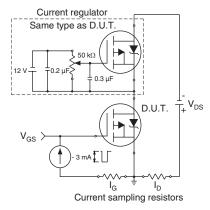
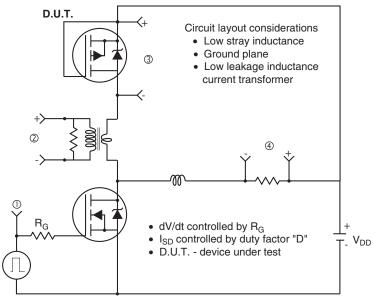


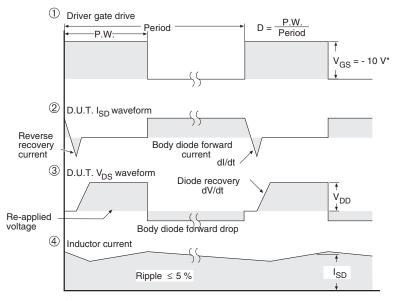
Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



\*  $V_{GS} = -5$  V for logic level and -3 V drive devices Fig. 14 - For P-Channel

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